

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Chiyeh LU</td> <td>03/31/2009</td> </tr> <tr> <td>Shihpin HUANG</td> <td>03/31/2009</td> </tr> <tr> <td>Chengfeng YANG</td> <td>03/31/2009</td> </tr> </tbody> </table>		Name	Execution Date	Chiyeh LU	03/31/2009	Shihpin HUANG	03/31/2009	Chengfeng YANG	03/31/2009				
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>CHI MEI OPTOELECTRONICS CORP.</td> </tr> <tr> <td>Street Address:</td> <td>No. 1, Chi-Yeh Road</td> </tr> <tr> <td>Internal Address:</td> <td>Tainan Science Based Industrial Park</td> </tr> <tr> <td>City:</td> <td>Tainan County</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> <tr> <td>Postal Code:</td> <td>74147</td> </tr> </table>		Name:	CHI MEI OPTOELECTRONICS CORP.	Street Address:	No. 1, Chi-Yeh Road	Internal Address:	Tainan Science Based Industrial Park	City:	Tainan County	State/Country:	TAIWAN	Postal Code:	74147
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CORRESPONDENCE DATA													
<p>Fax Number: (703)518-5499</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 7036841111</p> <p>Email: bjhgroup@ipfirm.com</p> <p>Correspondent Name: Benjamin Hauptman</p> <p>Address Line 1: 1700 DIAGONAL ROAD</p> <p>Address Line 2: SUITE 300</p> <p>Address Line 4: ALEXANDRIA, VIRGINIA 22314</p>													
ATTORNEY DOCKET NUMBER:	4698-066												
NAME OF SUBMITTER:	Benjamin J. Hauptman												
Total Attachments: 2													

OP \$40.00 12414821

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PATENT
REEL: 022474 FRAME: 0804

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ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) LU,CHIYEH
- 2) HUANG, SHIHPIN
- 3) YANG, CHENG FENG

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

CHI MEI OPTOELECTRONICS CORP. having a place of business at No. 1, Chi-Yeh Road, Tainan County,
Tainan Science Based Industrial Park, Taiwan 74147

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

BACKLIGHT MODULE, APPLICATION AND FABRICATION METHOD THEREOF

(a) for which an application for United States Letters Patent was filed on 31MAR2009, and identified by United States Patent Application No. 12/414,821; or

(b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) LU, CHIEH
Name: LU, CHIEH

2009.3.31
Date:

2) Huang, shih pin
Name: HUANG, SHIHPIN

2009.3.31
Date:

3) Yang, Cheng Feng
Name: YANG, CHENGFENG

2009.3.31
Date: